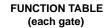
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 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

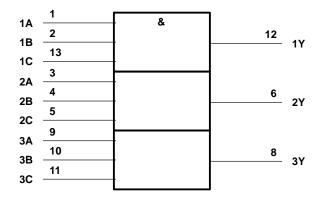
These devices contain three independent 3-input positive-AND gates. They perform the Boolean functions $Y = A \cdot B \cdot C$ or $Y = \overline{A} + \overline{B} + \overline{C}$ in positive logic.

The SN54ALS11A and SN54AS11 are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS11A and SN74AS11 are characterized for operation from 0°C to 70°C.



	INPUTS	OUTPUT	
Α	В	С	Y
Н	Н	Н	Н
L	Х	Х	L
Х	L	Х	L
Х	Х	L	L

logic symbol[†]



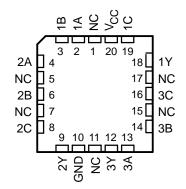
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

SN54ALS11A, SN54AS11 ... J PACKAGE SN74ALS11A, SN74AS11 ... D OR N PACKAGE (TOP VIEW)

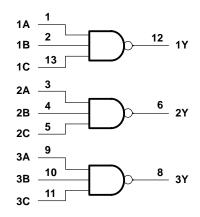
	(
1A 1B 2A 2B 2C 2Y GND	[] 3 [] 4 [] 5	14 13 12 11 10 9 8] V _{CC}] 1C] 1Y] 3C] 3B] 3A] 3Y

SN54ALS11A, SN54AS11 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Operating free-air temperature range, T _A : SN54ALS11A	-55°C to 125°C
SN74ALS11A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	54ALS11A		SN74ALS11A			UNIT
		MIN NOM MAX MIN NOM MA		MAX				
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
	Low-level input voltage			0.8‡			0.8	V
VIL				0.7§				v
IOH	High-level output current			-0.4			-0.4	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C
					_			

[‡] Applies over temperature range – 55°C to 70°C

§ Applies over temperature range 70°C to 125°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TERTO	ONDITIONS	SN	54ALS1 [,]	1A	SN	74ALS1 [,]	IA	UNIT
PARAMETER	IESI C	TEST CONDITIONS		τγρ¶	MAX	MIN	τγρ¶	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = –18 mA			-1.5			-1.5	V
VOH	$V_{CC} = 4.5 V \text{ to } 5.5 V,$	I _{OH} = -0.4 mA	V _{CC} -2	2		V _{CC} -2	2		V
Vol	VCC = 4.5 V	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	V
VOL	VCC = 4.3 V	I _{OL} = 8 mA					0.35	0.5	v
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
Чн	V _{CC} = 5.5 V,	VI = 2.7 V			20			20	μA
١ _{١L}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
IO [#]	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
Іссн	V _{CC} = 5.5 V,	V _I = 4.5 V		1	1.8		1	1.8	mA
ICCL	V _{CC} = 5.5 V,	V _I = 0		1.6	3		1.6	3	mA

¶ All typical values are at V_{CC} = 5 V, T_A = 25°C.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	то (оитрит)	V _C C _L R _L T _A	UNIT			
			SN54A	LS11A	SN74A	LS11A	
			MIN	MAX	MIN	MAX	
^t PLH	A B or C	v	2	14	2	13	200
^t PHL	A, B, or C	· · ·	2	12.5	2	10	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Operating free-air temperature range, T _A : SN54AS11	-55°C to 125°C
SN74AS11	
Storage temperature range	−65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS11		S	UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			-2	mA
IOL	Low-level output current			20			20	mA
Т _А	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TERTO	TEST CONDITIONS		SN54AS11			SN74AS11			
PARAMETER	IESI C			TYP§	MAX	MIN	TYP§	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	l _l = –18 mA			-1.2			-1.2	V	
VOH	V_{CC} = 4.5 V to 5.5 V,	I _{OH} = -2 mA	V _{CC} -2	2		V _{CC} -2	2		V	
VOL	V _{CC} = 4.5 V,	I _{OL} = 20 mA		0.35	0.5		0.35	0.5	V	
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
IIН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA	
١L	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.5			-0.5	mA	
۱ _О ¶	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA	
IССН	V _{CC} = 5.5 V,	V _I = 4.5 V		4.3	7		4.3	7	mA	
ICCL	V _{CC} = 5.5 V,	V _I = 0		11.2	18		11.2	18	mA	

[§] All typical values are at V_{CC} = 5 V, T_A = 25°C.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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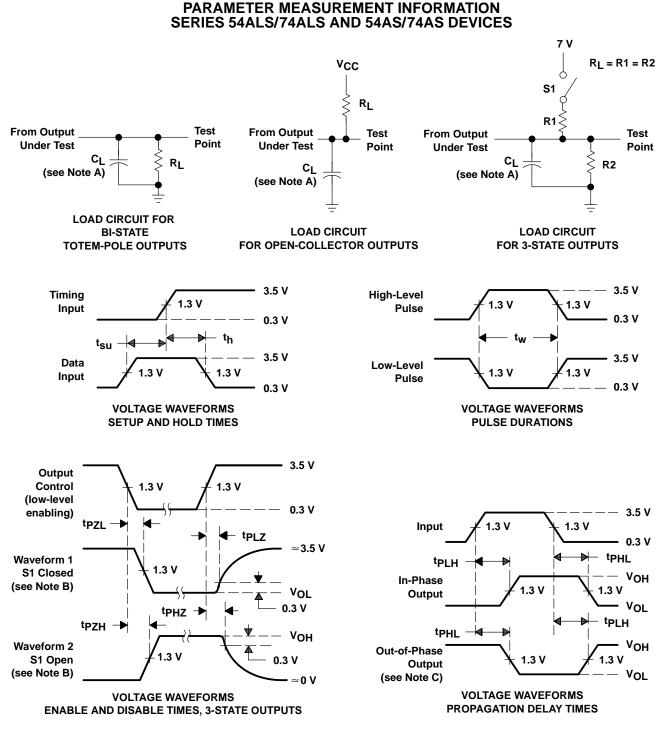
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	то (OUTPUT)	V _C C _L R _L T _A SN54	UNIT			
			MIN	MAX	MIN	MAX	
^t PLH	A, B, or C	v	1	6.5	1	6	ns
^t PHL	A, B, 01 C	Ť	1	6.5	1	5.5	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

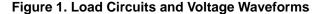


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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.





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